

IGBT MODULE (U series) 1200V / 25A / PIM



■ Features

- Low $V_{CE(sat)}$
- Compact Package
- P.C. Board Mount Module
- Converter Diode Bridge Dynamic Brake Circuit

■ Applications

- Inverter for Motoe Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply

■ Maximum ratings and characteristics

● Absolute maximum ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Condition	Rating	Unit	
Inverter	Collector-Emitter voltage	V_{CES}	1200	V	
	Gate-Emitter voltage	V_{GES}	± 20	V	
	Collector current	I_c	Continuous	$T_c=25^\circ\text{C}$	25
				$T_c=80^\circ\text{C}$	15
		I_{CP}	1ms	$T_c=25^\circ\text{C}$	50
				$T_c=80^\circ\text{C}$	30
		$-I_c$		25	
$-I_c$ pulse	1ms	50			
Collector power dissipation	P_c	1 device	115	W	
Brake	Collector-Emitter voltage	V_{CES}	1200	V	
	Gate-Emitter voltage	V_{GES}	± 20	V	
	Collector current	I_c	Continuous	$T_c=25^\circ\text{C}$	25
				$T_c=80^\circ\text{C}$	15
		I_{CP}	1ms	$T_c=25^\circ\text{C}$	50
				$T_c=80^\circ\text{C}$	30
	Collector power dissipation	P_c	1 device	115	W
Repetitive peak reverse voltage	V_{RRM}		1200	V	
Converter	Repetitive peak reverse voltage	V_{RRM}	1600	V	
	Average output current	I_o	50Hz/60Hz sine wave	25	
	Surge current (Non-Repetitive)	I_{FSM}	$T_j=150^\circ\text{C}$, 10ms	260	
	I^2t (Non-Repetitive)	I^2t	half sine wave		338
					A^2s
Operating junction temperature	T_j		+150	$^\circ\text{C}$	
Storage temperature	T_{stg}		-40 to +125	$^\circ\text{C}$	
Isolation voltage	between terminal and copper base *2	V_{iso}	AC : 1 minute	AC 2500	
	between thermistor and others *3			AC 2500	
Mounting screw torque			3.5 *1	N·m	

*1 Recommendable value : 2.5 to 3.5 N·m (M5)

*2 All terminals should be connected together when isolation test will be done.

*3 Two thermistor terminals should be connected together, each other terminals should be connected together and shorted to base plate when isolation test will be done.

● Electrical characteristics (T_j=25°C unless otherwise specified)

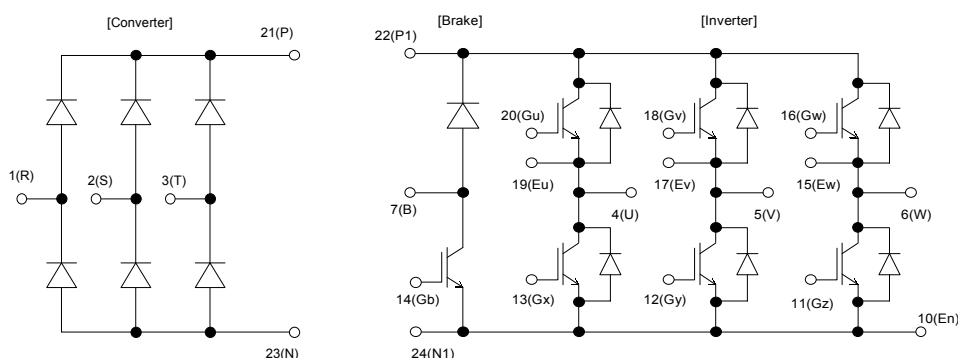
Item	Symbol	Condition	Characteristics			Unit		
			Min.	Typ.	Max.			
Inverter	Zero gate voltage collector current	ICES	V _{CE} =1200V, V _{GE} =0V		-	1.0	mA	
	Gate-Emitter leakage current	IGES	V _{CE} =0V, V _{GE} =±20V		-	200	nA	
	Gate-Emitter threshold voltage	V _{GE(th)}	V _{CE} =20V, I _C =25mA		4.5	6.5	8.5	V
	Collector-Emitter saturation voltage	V _{CE(sat)} (terminal)	V _{GE} =15V I _C =25A	T _J =25°C	-	2.30	2.80	V
				T _J =125°C	-	2.75	-	
		V _{CE(sat)} (chip)		T _J =25°C	-	2.10	2.60	
				T _J =125°C	-	2.55	-	
	Input capacitance	C _{ies}	V _{GE} =0V, V _{CE} =10V, f=1MHz		-	2	-	nF
	Turn-on time	t _{on}	V _{CC} =600V		-	0.41	1.20	μs
		t _r	I _C =25A		-	0.28	0.60	
		t _{r(i)}	V _{GE} =±15V		-	0.03	-	
	Turn-off time	t _{off}	R _G = 68 Ω		-	0.37	1.00	μs
t _f				-	0.07	0.30		
Forward on voltage	V _F (terminal)	V _{GE} = 0 V I _F =25A	T _J =25°C	-	2.95	3.55	V	
			T _J =125°C	-	2.55	-		
	V _F (chip)		T _J =25°C	-	2.75	3.35		
			T _J =125°C	-	2.35	-		
Reverse recovery time	t _{rr}	I _F =25A		-	-	0.35	μs	
Brake	Zero gate voltage collector current	ICES	V _{CE} =1200V, V _{GE} =0V		-	1.0	mA	
	Gate-Emitter leakage current	IGES	V _{CE} =0V, V _{GE} =±20V		-	200	nA	
	Collector-Emitter saturation voltage	V _{CE(sat)} (terminal)	I _C =25A V _{GE} =15V	T _J =25°C	-	2.30	2.80	V
				T _J =125°C	-	2.75	-	
		V _{CE(sat)} (chip)		T _J =25°C	-	2.10	2.60	
				T _J =125°C	-	2.55	-	
	Turn-on time	t _{on}	V _{CC} =600V		-	0.41	1.20	μs
		t _r	I _C =25A		-	0.28	0.60	
	Turn-off time	t _{off}	V _{GE} =±15V		-	0.37	1.00	μs
		t _f	R _G = 68 Ω		-	0.07	0.30	
	Reverse current	I _{RRM}	V _R =1200V		-	-	1.0	mA
	Converter	Forward on voltage	V _{FM}	I _F =25 A	terminal	-	1.20	1.50
V _{GE} =0V				chip	-	1.10	-	
Reverse current	I _{RRM}	V _R =1600V		-	-	1.0	mA	
Thermistor	Resistance	R	T=25°C	-	5000	-	Ω	
			T=100°C	465	495	520		
B value	B	T=25/50°C		3305	3375	3450	K	

● Thermal resistance Characteristics

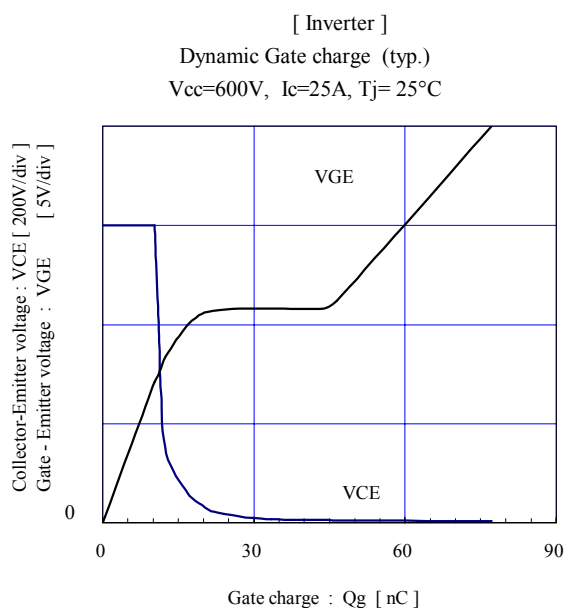
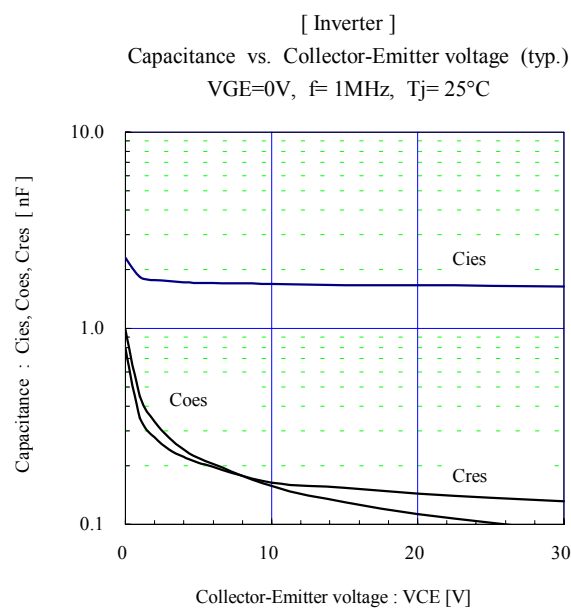
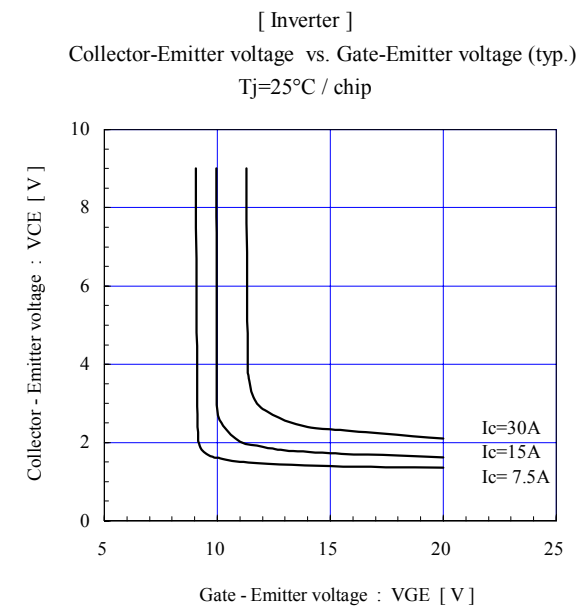
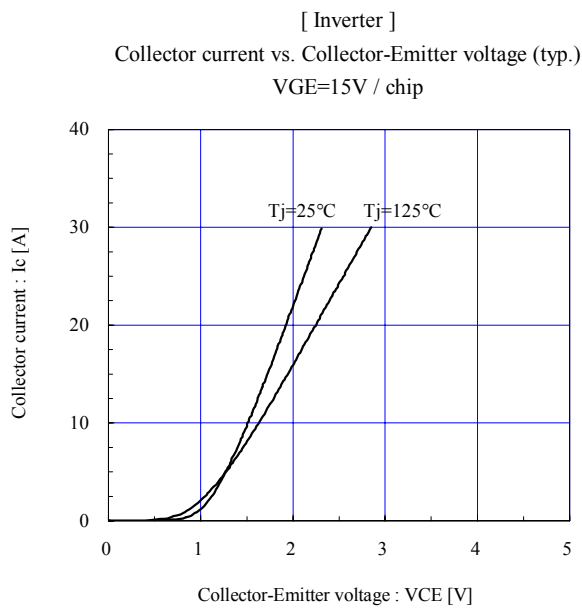
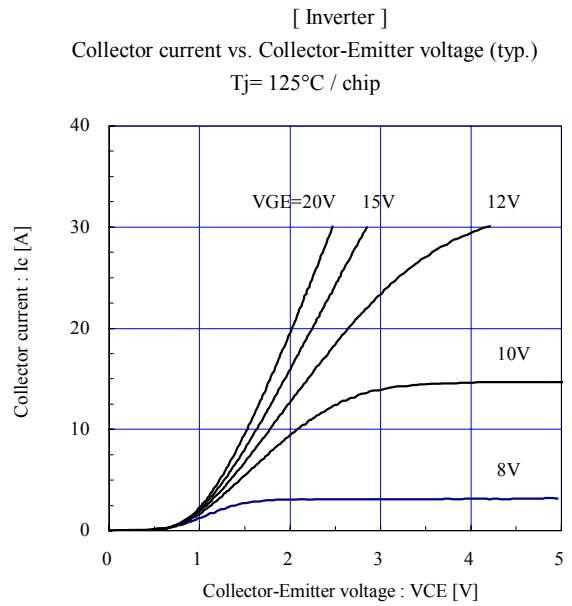
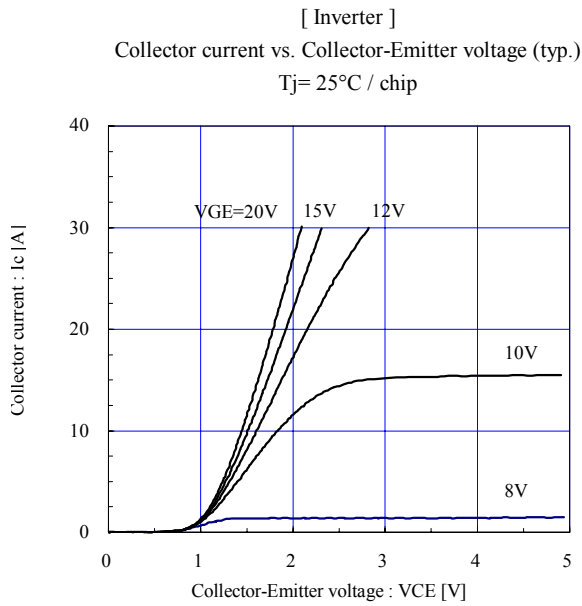
Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance (1 device)	R _{th(j-c)}	Inverter IGBT	-	-	1.07	°C/W
		Inverter FWD	-	-	1.58	
		Brake IGBT	-	-	1.07	
		Converter Diode	-	-	0.90	
Contact thermal resistance *	R _{th(c-f)}	With thermal compound	-	0.05	-	

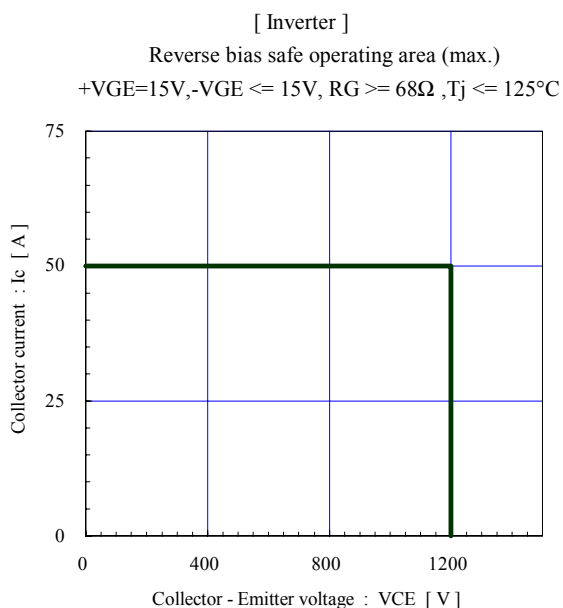
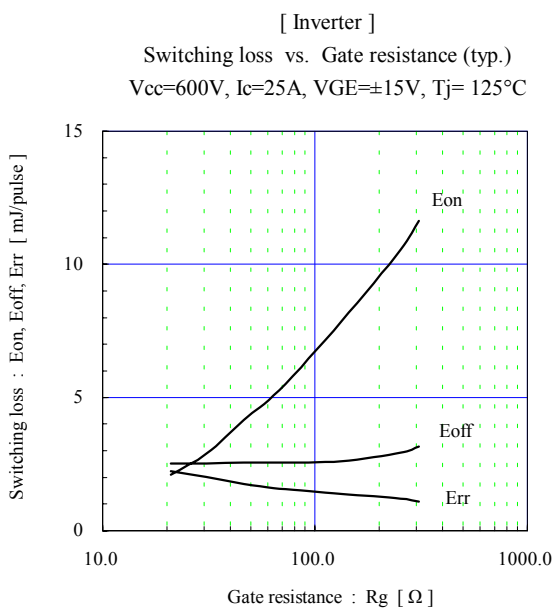
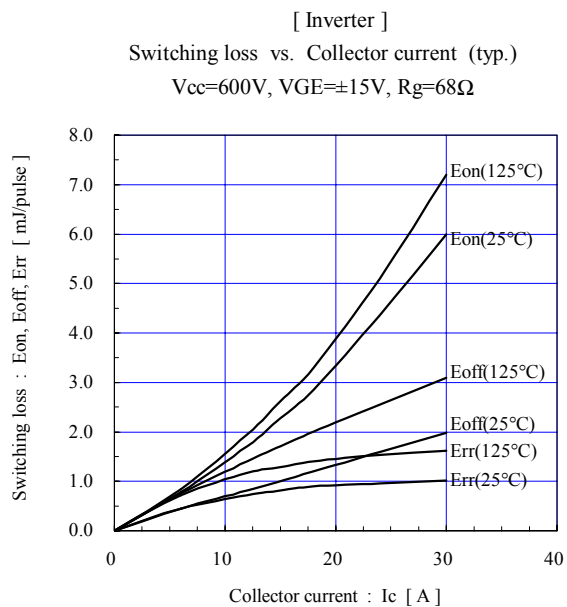
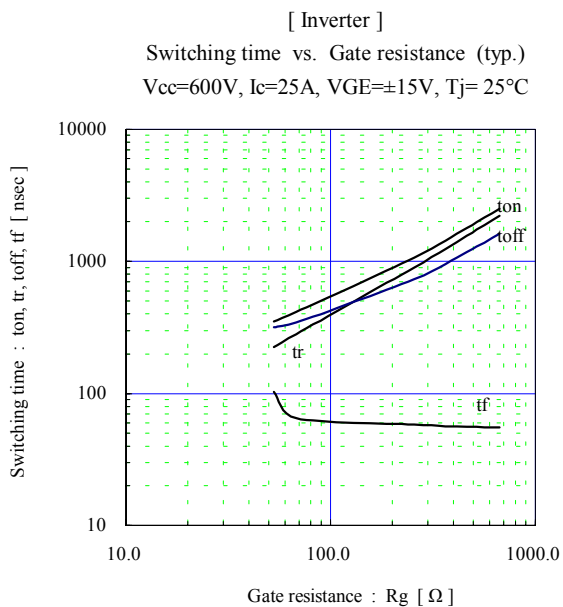
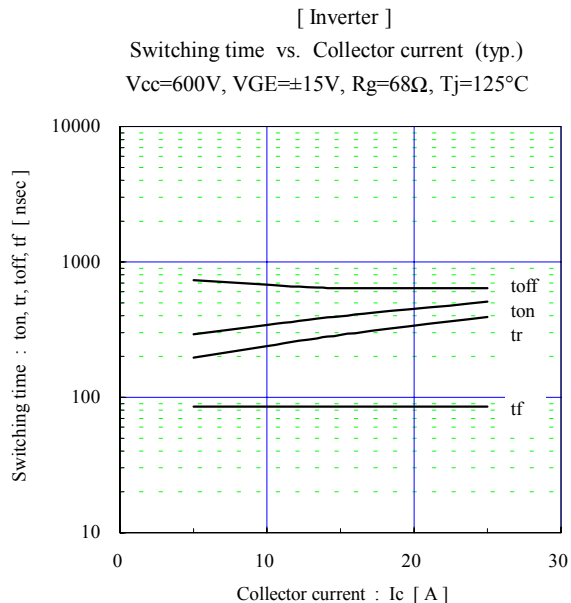
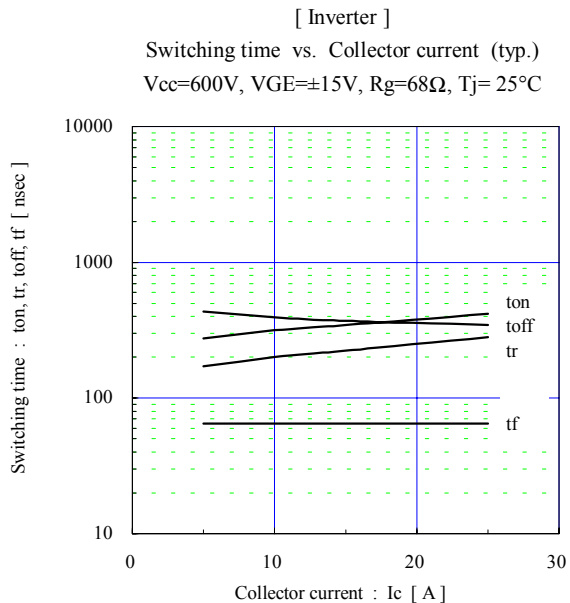
* This is the value which is defined mounting on the additional cooling fin with thermal compound

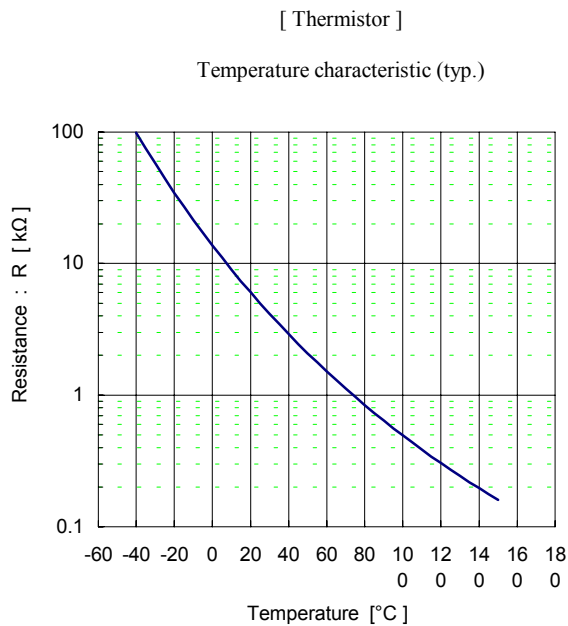
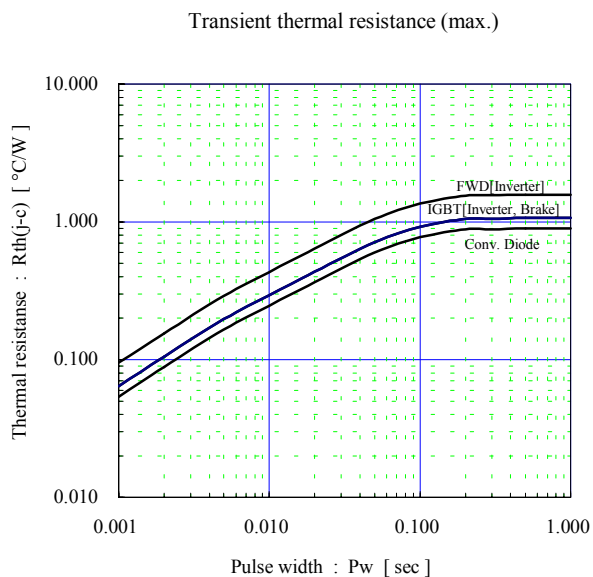
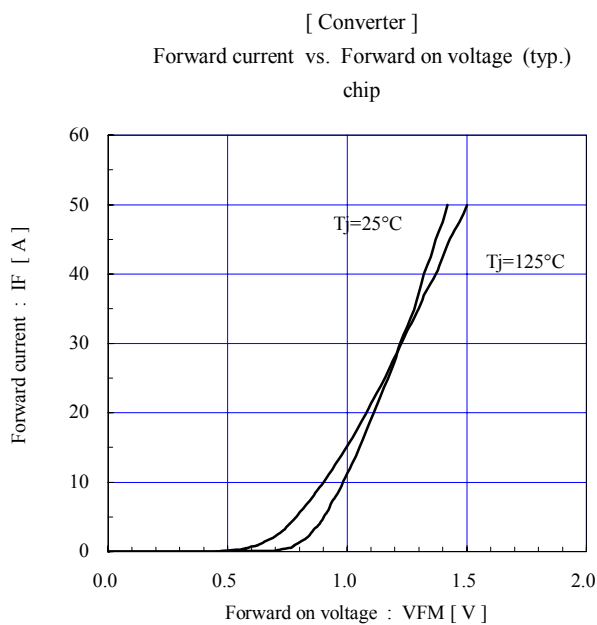
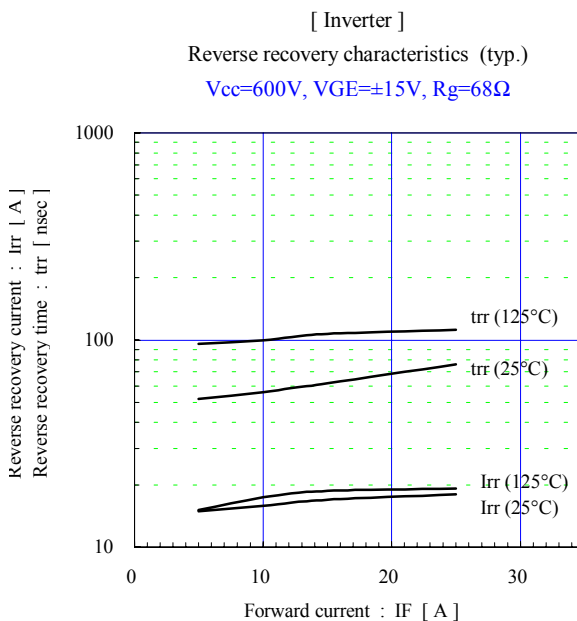
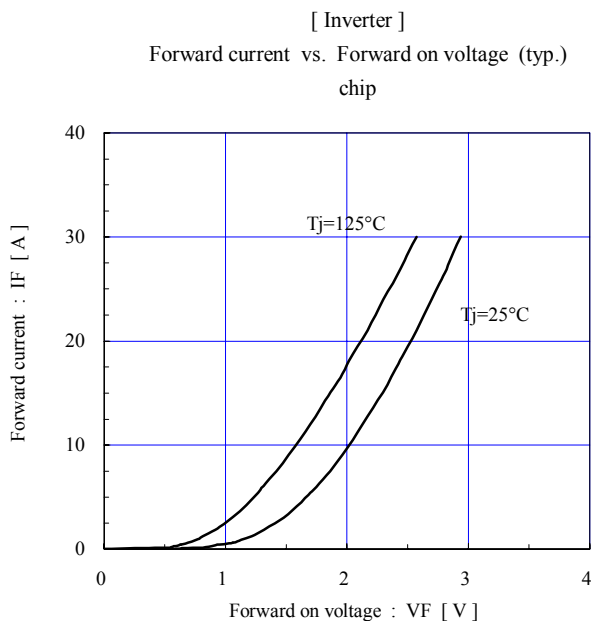
■ Equivalent Circuit Schematic

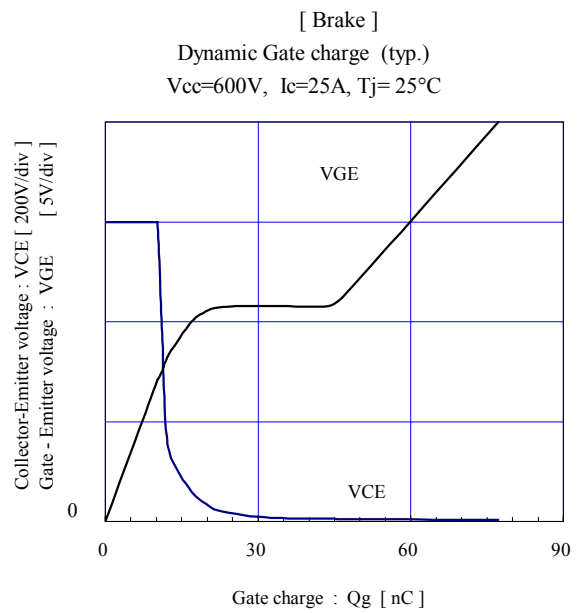
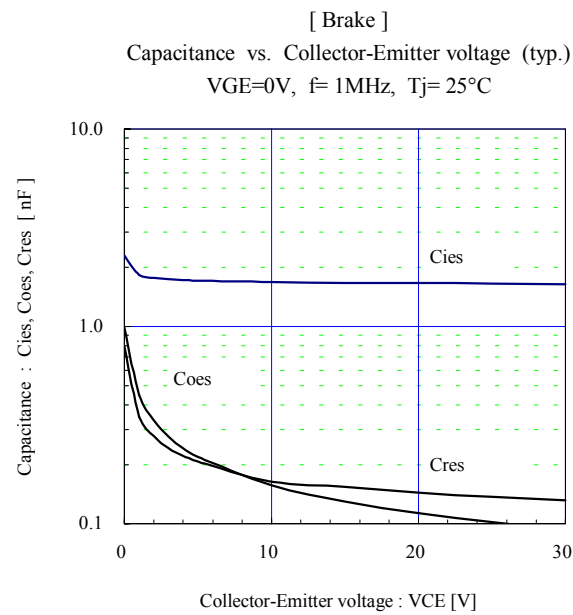
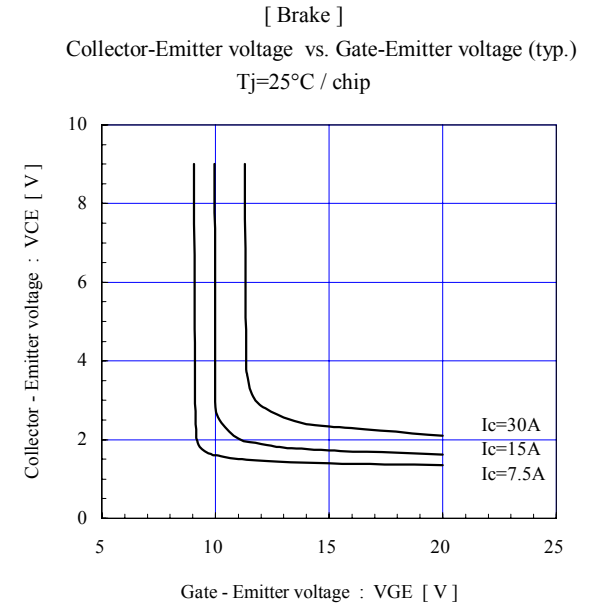
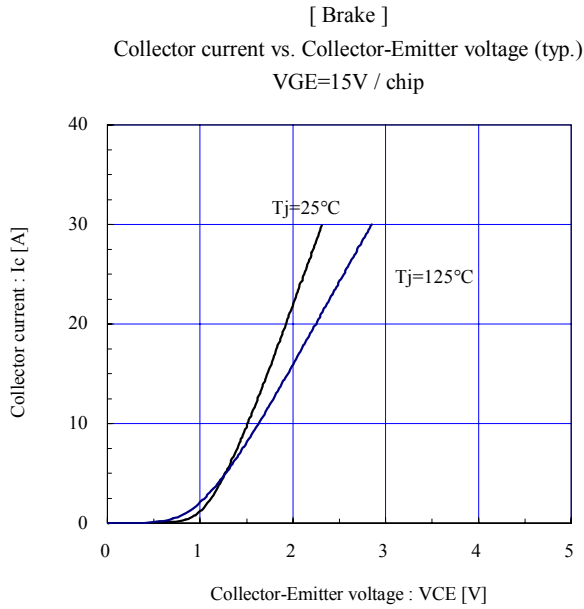
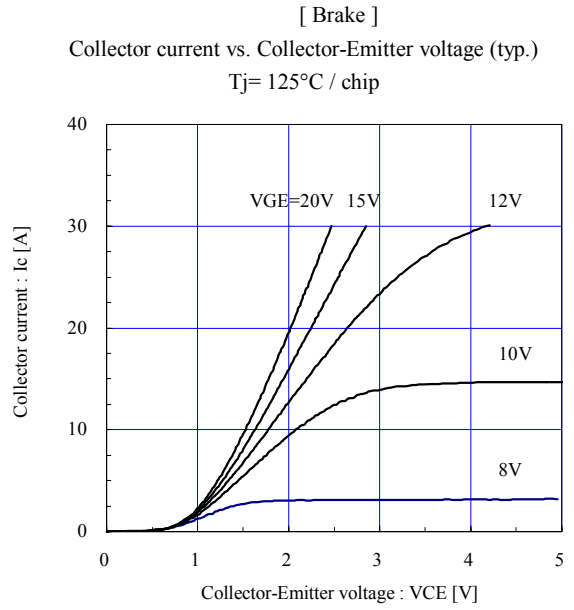
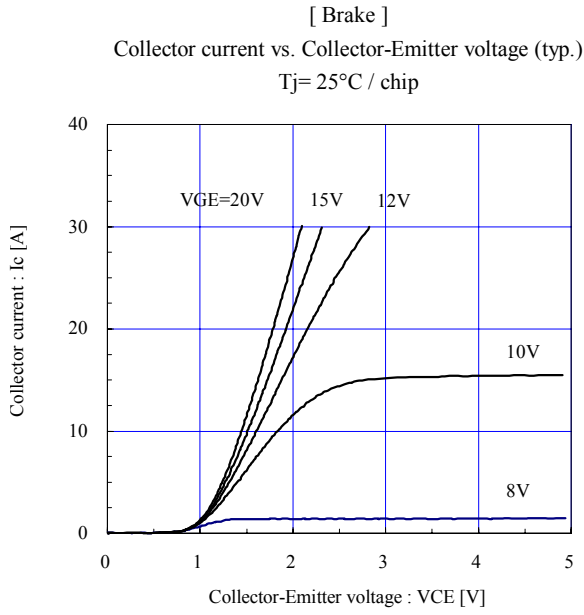


■ Characteristics (Representative)

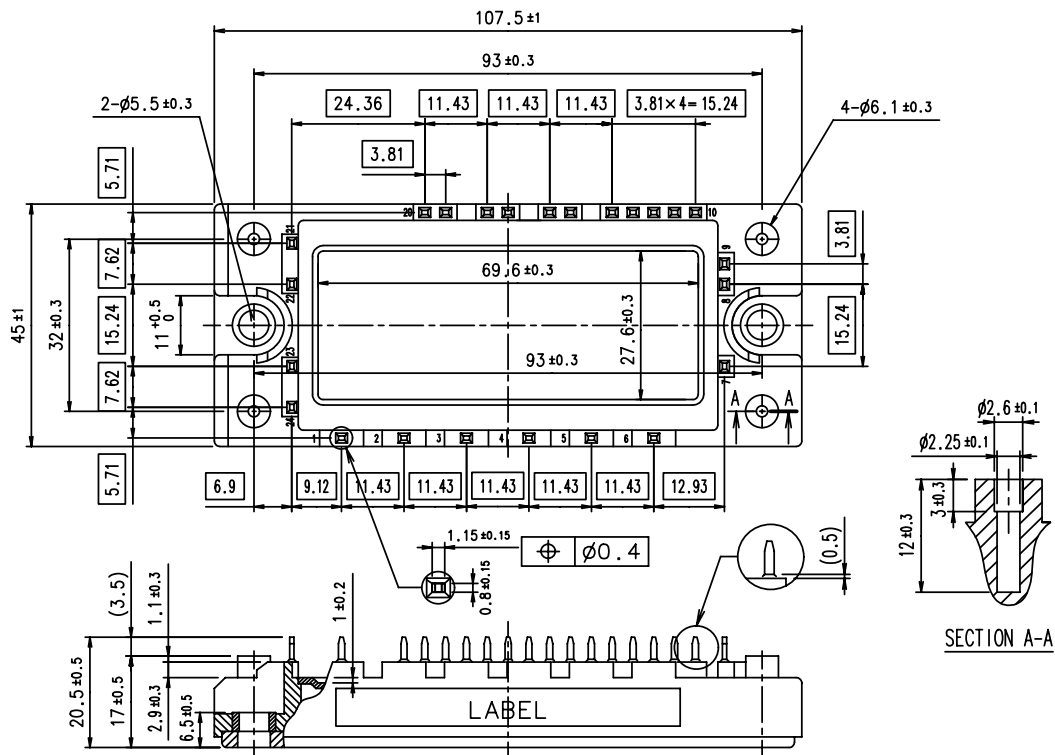








■ Outline Drawings, mm



□ shows theoretical dimension.
 () shows reference dimension.